PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company	577	STMicroelectronics International N.V
1.2 PCN No.		ADG/21/13069
1.3 Title of PCN		IGBT/IPM TFS Technology Front End expansipon - External Samsung Foundry (Korea) - Industrial
1.4 Product Category		IGBT's/IPM
1.5 Issue date		2021-10-22

	2. PCN Team
2.1 Contact supplier	
2.1.1 Name	KRAUSE INA
2.1.2 Phone	+49 89460062370
2.1.3 Email	ina.krause@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Angelo RAO
2.1.2 Marketing Manager	Natale Sandro D'ANGELO
2.1.3 Quality Manager	Vincenzo MILITANO

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
General	Wafer diameter modification	Samsung - Korea

	4. Description of change	
	Old	New
4.1 Description	IGBT/IPM TFS products are manufactured in Catania (Italy) and Ang Mo Kio (Singapore)	IGBT/IPM TFS products will be manufactured in external Samsung Foundry (Korea)
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no impact	

5. Reason / motivation for change	
5.1 Motivation	Capacity expansion
5.2 Customer Benefit	CAPACITY INCREASE

	6. Marking of parts / traceability of change	
6.1 Description	By internal traceability and dedicated FG code.	

	7. Timing / schedule
7.1 Date of qualification results	2021-11-13
7.2 Intended start of delivery	2022-01-17
7.3 Qualification sample available?	Upon Request

	8. Qualification / Validation		
8.1 Description	13069 Binder1.pdf		
8.2 Qualification report and qualification results		Issue Date	2021-10-22

9. Attachments (additional documentations)

13069 Public product.pdf 13069 IGBT IPM TFS - Front end expansion to outsource (Samsung).pdf 13069 Binder1.pdf

10. Affected parts		
	10. 1 Current	10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STGD5H60DF	
	STGW40H60DLFB	
	STGWT40HP65FB	
2987026	STGIB10CH60S-L	
3678914	STGIPQ4C60T-HZ	

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